#### STP310N10F7



# N-channel 100 V, 2.3 mΩ typ., 180 A STripFET™ VII DeepGATE™ Power MOSFET in a TO-220 package

Datasheet - production data

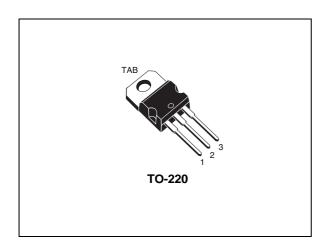
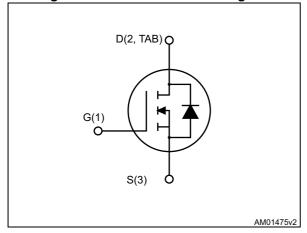


Figure 1. Internal schematic diagram



#### **Features**

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	I <sub>D</sub>
STP310N10F7	100 V	$2.7~\text{m}\Omega$	180 A

- Ultra low on-resistance
- 100% avalanche tested

#### **Applications**

• Switching applications

#### **Description**

This device utilizes the 7<sup>th</sup> generation of design rules of ST's proprietary STripFET<sup>TM</sup> technology, with a new gate structure. The resulting Power MOSFET exhibits the lowest  $R_{DS(on)}$  in all packages.

Table 1. Device summary

Order codes	Marking	Package	Packaging
STP310N10F7	310N10F7	TO-220	Tube

Contents STP310N10F7

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STP310N10F7 Electrical ratings

## 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage	100	V
V <sub>GS</sub>	Gate-source voltage	± 20	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25°C	180	А
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> =100°C	120	А
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	720	А
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25°C	315	W
	Derating factor	2.1	W/°C
E <sub>AS</sub> <sup>(3)</sup>	Single pulse avalanche energy (T <sub>J</sub> = 25 °C, L=0.55 mH, I <sub>as</sub> =65 A)	1	J
T <sub>j</sub> T <sub>stg</sub>	Operating junction temperature storage temperature	- 55 to 175	°C

<sup>1.</sup> Current limited by package.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	0.48	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient max	62.5	°C/W

<sup>2.</sup> Pulse width limited by safe operating area.

<sup>3.</sup> Starting  $T_J=25$  °C,  $I_D=60$  A,  $V_{DD}=50$  V

Electrical characteristics STP310N10F7

### 2 Electrical characteristics

(T<sub>CASE</sub> = 25 °C unless otherwise specified).

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage (V <sub>GS</sub> = 0)	I <sub>D</sub> = 250 μA	100			V
lana	I <sub>DSS</sub> Zero gate voltage drain current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = 100 V			1	μΑ
DSS		V <sub>DS</sub> = 100 V, T <sub>C</sub> = 125°C			100	μΑ
I <sub>GSS</sub>	Gate body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = 20 V			100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5	3.5	4.5	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 60 A		2.3	2.7	mΩ

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	12800	-	pF
C <sub>oss</sub>	Output capacitance	$V_{DS} = 25 \text{ V, f} = 1 \text{ MHz,}$ $V_{GS} = 0$	-	3500	-	pF
C <sub>rss</sub>	Reverse transfer capacitance		-	170	-	pF
Qg	Total gate charge	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 180 A, V <sub>GS</sub> = 10 V	-	180	-	nC
$Q_{gs}$	Gate-source charge		-	78	-	nC
Q <sub>gd</sub>	Gate-source charge	(see <i>Figure 14</i> )	-	34	-	nC

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 50 \text{ V}, I_{D} = 90 \text{ A}$ $R_{G} = 4.7 \Omega V_{GS} = 10 \text{ V}$ (see Figure 13, Figure 18)	-	62	-	ns
t <sub>r</sub>	Rise time		-	108	-	ns
t <sub>d(off)</sub>	Turn-off delay time		-	148	-	ns
t <sub>f</sub>	Fall time	rigule 10)	-	40	-	ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		180	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		720	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> =60 A, V <sub>GS</sub> =0	-		1.5	V
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> =180 A,	-	85		ns
Q <sub>rr</sub>	Reverse recovery charge	di/dt = 100 A/µs, V <sub>DD</sub> =80 V, Tj=150°C	-	200		nC
I <sub>RRM</sub>	Reverse recovery current	(see Figure 15)	-	4.7		Α

<sup>1.</sup> Pulse width limited by safe operating area.

<sup>2.</sup> Pulse duration = 300µs, duty cycle 1.5%

Electrical characteristics STP310N10F7

1ms

10ms

V<sub>DS</sub>(V)

### 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

(A)

100

10

1

AM14733v1

Figure 3. Thermal impedance

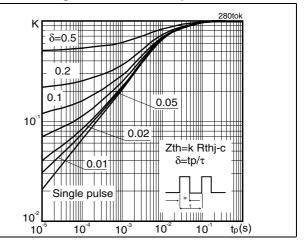


Figure 4. Output characteristics

Tj=175°C

Tc=25°C

Sinlge

pulse

AM14734v1

(A) VGS=10V

300

8V

7V

250

150

100

6V

50

0

2 4 6 8 VDS(V)

Figure 5. Transfer characteristics

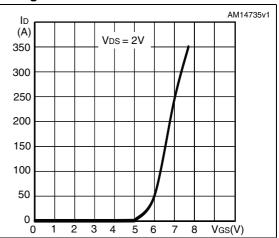
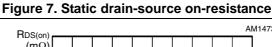
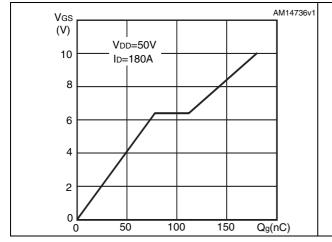
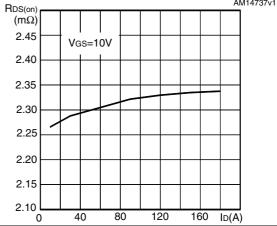


Figure 6. Gate charge vs gate-source voltage







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Figure 8. Capacitance variations

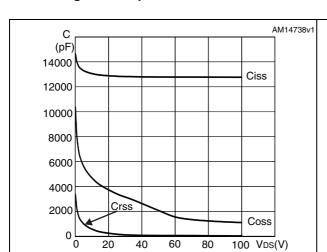


Figure 9. Source-drain diode forward characteristics

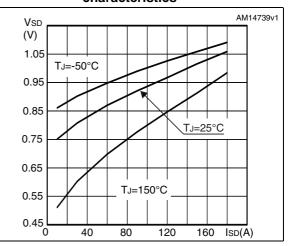


Figure 10. Normalized gate threshold voltage vs temperature

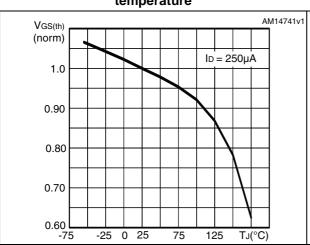


Figure 11. Normalized on-resistance vs temperature

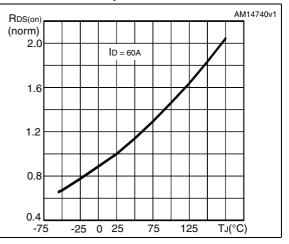
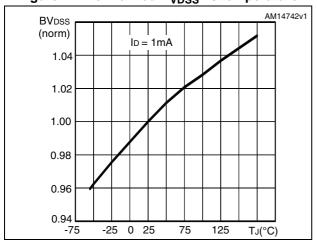


Figure 12. Normalized  $B_{VDSS}$  vs temperature



Test circuits STP310N10F7

#### 3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

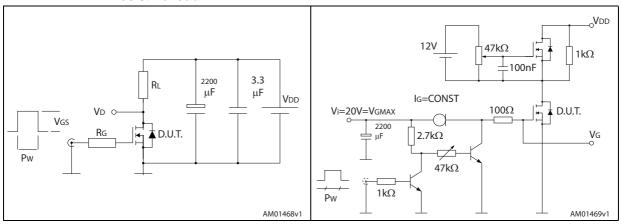


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped inductive load test circuit

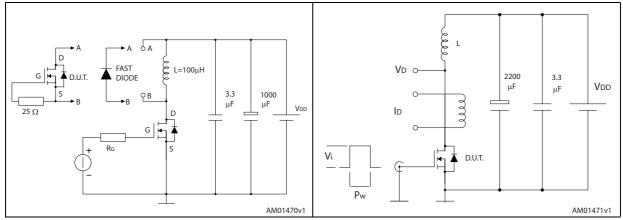
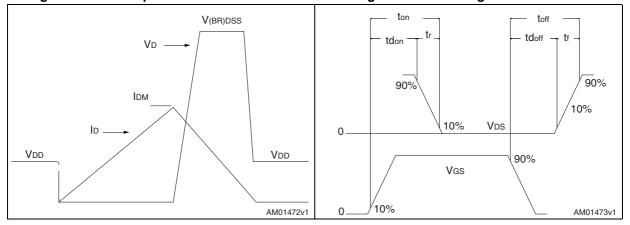


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



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## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.



Table 8. TO-220 type A mechanical data

D:	Dim		
Dim.	Min.	Тур.	Max.
А	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
С	0.48		0.70
D	15.25		15.75
D1		1.27	
Е	10		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ØP	3.75		3.85
Q	2.65		2.95

øΡ Ε H1 D <u>D1</u> L20 L30 b1(X3) -- b (X3) \_e1\_\_\_ 0015988\_typeA\_Rev\_T

Figure 19. TO-220 type A drawing

Revision history STP310N10F7

## 5 Revision history

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**Table 9. Document revision history** 

Date	Revision	Changes
19-Oct-2011	1	Initial version.
21-Dec-2011	2	Updated title and description in cover page.
06-Mar-2012	3	Updated $I_D$ value at $T_C$ = 25°C in the whole document. <i>Table 5, Table 6</i> and <i>Table 7</i> have been updated with typical values.
20-Aug-2012	4	Document status promoted from preliminary to production data.  Added Section 2.1: Electrical characteristics (curves).  Minor text changes.
31-Oct-2012	5	<ul> <li>Added: H<sup>2</sup>PAK-2 and H<sup>2</sup>PAK-6 packages</li> <li>Updated: Section 4: Package mechanical data and Section 4: Package mechanical data</li> <li>Minor text changes</li> </ul>
07-Dec-2012	6	<ul> <li>Minor text changes</li> <li>The part numbers STH310N10F7-2, STH310N10F7-6 have been moved to a separate datasheet</li> </ul>
31-Jul-2013	7	<ul> <li>Modified: I<sub>DSS</sub> and V<sub>GS(th)</sub> values in <i>Table 4</i>.</li> <li>Minor text changes</li> <li>Inserted: E<sub>AS</sub> value in <i>Table 2</i></li> </ul>

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